CA3275

April 1994

## **Dual Full Bridge Driver**

#### Features

- Two Full Bridge Drivers
- ± 150mA Maximum Current
- Logic Controlled Switching
- Direction Control
- PWM I<sub>OUT</sub> Control
- 18V Over-Voltage Protection
- 300mA Short-Circuit Protection
- · Nominal 8V to 16V Operation
- Internal Voltage Regulation With Bandgap Reference

## **Applications**

- Dual Full Bridge Driver For Air Core Gauge Instrumentation
- μP Controlled Sensor Data Displays
- Speedometer Displays
- · Tachometer Displays
- Stepper Motors
- Slave Position Indicators

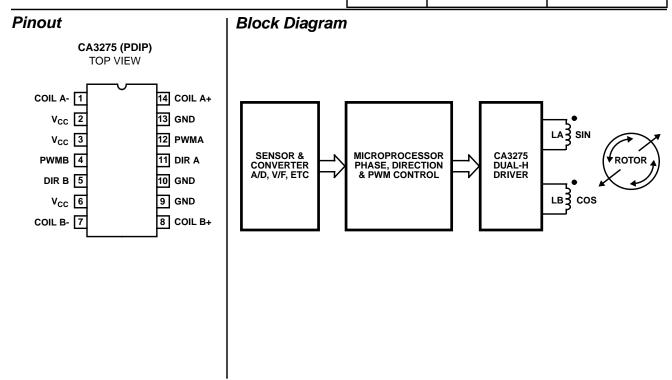
### Description

The CA3275 Dual Full Bridge Driver is intended for general-purpose applications requiring Dual Full Bridge drive or switching, including direction and pulse-width modulation for position control. While all features of the IC may not be utilized or required, they would normally be used in instrumentation systems with quadrature coils, such as air-core gauges, where the coils would be driven at frequencies ranging from 200Hz to 400Hz. The coils are wrapped at 90° angles for independent direction control. Coils wound in this physical configuration are controlled by pulse width modulation, where each coil drive is a function of the sine or cosine versus degrees of movement. The direction control is used to change the direction of the current in the H-Driver coil.

The switch rate capability of the IC is typically 30kHz regardless of the inductive load. Over-current limiting is used to limit short circuit current. Over-voltage protection (in the range of 18V to 24V) causes the device to shut down the output current drive. Thermal shutdown limits power dissipation on the chip. The CA3275 is supplied in a 14 lead dual-inline plastic package.

### **Ordering Information**

PART NO.	TEMPERATURE	PACKAGE
CA3275E	-40°C to +85°C	14 Lead Plastic DIP



# **Specifications CA3275**

#### **Absolute Maximum Ratings**

Each Drive

# 

#### **Thermal Information**

$ \begin{array}{ccc} \text{Thermal Resistance} & \theta_{\text{JA}} \\ \text{PDIP Package} & 100^{\text{o}}\text{C/W} \end{array} $
Power Dissipation, P <sub>D</sub>
Up to +70°C800mW
Above +70°C Derate Linearly at 10mW/°C
Ambient Temperature Range
Operating40°C to +85°C
Storage
Lead Temperature (During Soldering)+265°C
At distance $1/16 + 1/32$ " (1.59 + 0.79mm) from case for 1.0s max

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### **Electrical Specifications** $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , $V_{CC} = 16\text{V}$ Unless Otherwise Specified

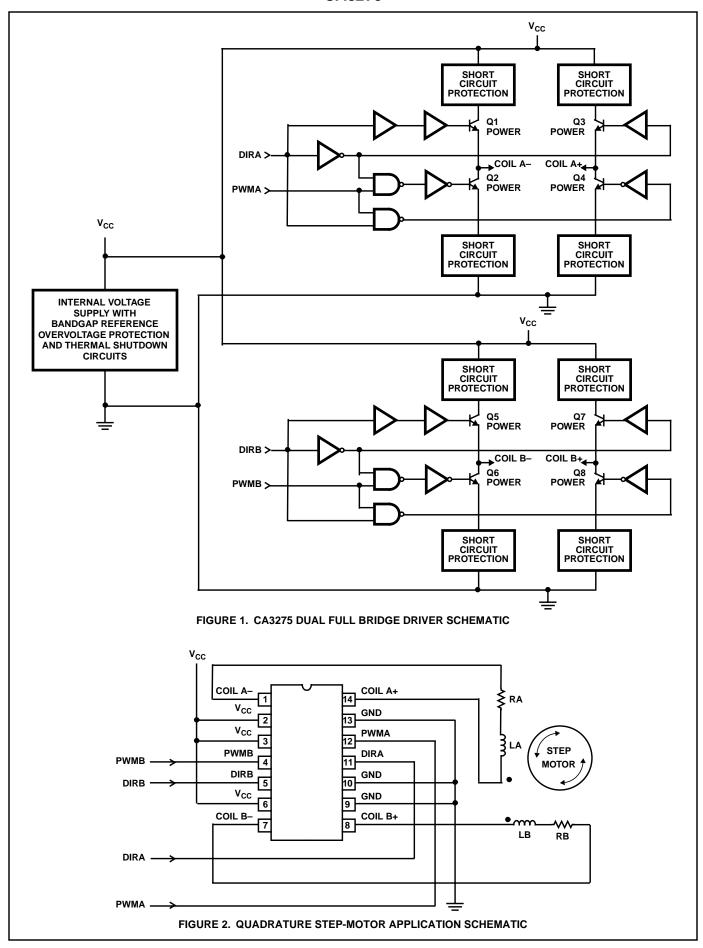
PARAMETERS	SYMBOL	MIN	TYP	MAX	UNITS
Operating Supply Voltage Range	V <sub>CC</sub>	8	-	16	V
Supply Current (Note 1)	I <sub>CC</sub>	-	8	20	mA
INPUT LEVELS					
Logic Input, Low Voltage	V <sub>IL</sub>	-	-	0.8	V
Logic Input, High Voltage	V <sub>IH</sub>	3.5	-	-	V
Logic Input, Low Current, V <sub>IL</sub> = 0V	I <sub>IL</sub>	-10	-	-	μΑ
Logic Input, High Current, V <sub>IH</sub> = 5V	Iн	-	-	10	μΑ
OUTPUT: RLA = RLB = $138\Omega$					
Maximum Source Saturated Voltage	V <sub>SAT</sub> - High	-	1.2	1.75	V
Maximum Sink Saturated Voltage	V <sub>SAT</sub> - Low	-	0.25	0.5	V
Differential V <sub>SAT</sub> Voltage, Both Outputs Saturated	Diff - V <sub>SAT</sub>	-	10	100	mV

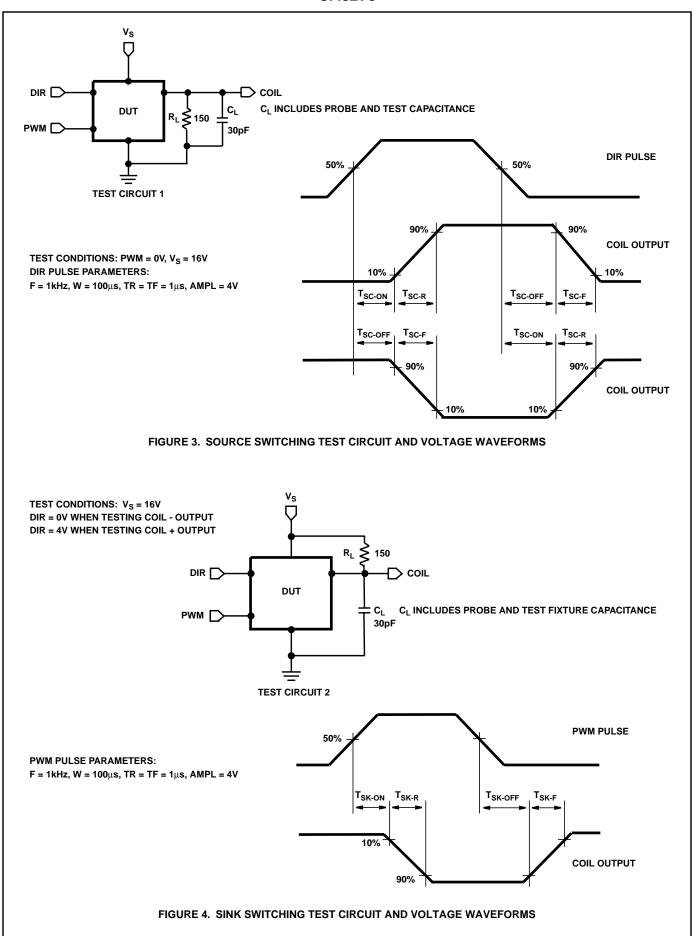
### **Switching Specifications**

PARAMETERS	SYMBOL	MIN	TYP	MAX	UNITS
SOURCE CURRENT (See Figure 3)	•	•	•	•	
Turn-Off Delay	T <sub>SC-OFF</sub>	-	-	2	μs
Fall Time	T <sub>SC-F</sub>	-	-	2.2	μs
Turn-On Time	T <sub>SC-ON</sub>	-	-	1	μs
Rise Time	T <sub>SC-R</sub>	-	-	0.4	μs
SINK CURRENT (See Figure 4)	•	•	•	•	
Turn-Off Delay	T <sub>SK-OFF</sub>	-	-	1.6	μs
Fall Time	T <sub>SK-F</sub>	-	-	0.4	μs
Turn-On Time	T <sub>SK-ON</sub>	-	-	0.6	μs
Rise Time	T <sub>SK-R</sub>	-	-	0.2	μs

#### NOTE:

1. No load, PWMA = PWMB = 5V, DIR A = DIR B = 0V





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Melbourne, FL 32902

TEL: (321) 727-9207 FAX: (321) 724-7240

100, Rue de la Fusee 1130 Brussels, Belgium TEL: (32) 2.724.2111 FAX: (32) 2.724.22.05

7F-6, No. 101 Fu Hsing North Road Taipei, Taiwan Republic of China TEL: (886) 2 2716 9310 FAX: (886) 2 2715 3029